

Low Charge Injection, 8-Channel, High Voltage Analog Switches with Bleed Resistors

Features

- ▶ HVCMOS® technology for high performance
- ▶ Very low quiescent power dissipation (-10µA max.)
- ▶ Output on-resistance typically (22Ω typ.)
- ▶ Integrated bleed resistors on the outputs
- ▶ Low parasitic capacitances
- ▶ DC to 50MHz small signal frequency response
- ▶ -60dB typical output OFF isolation at 5.0MHz
- ▶ CMOS logic circuitry for low power
- ▶ Excellent noise immunity
- ▶ ON-chip shift register, latch and clear logic circuitry
- ▶ Flexible high voltage supplies

Applications

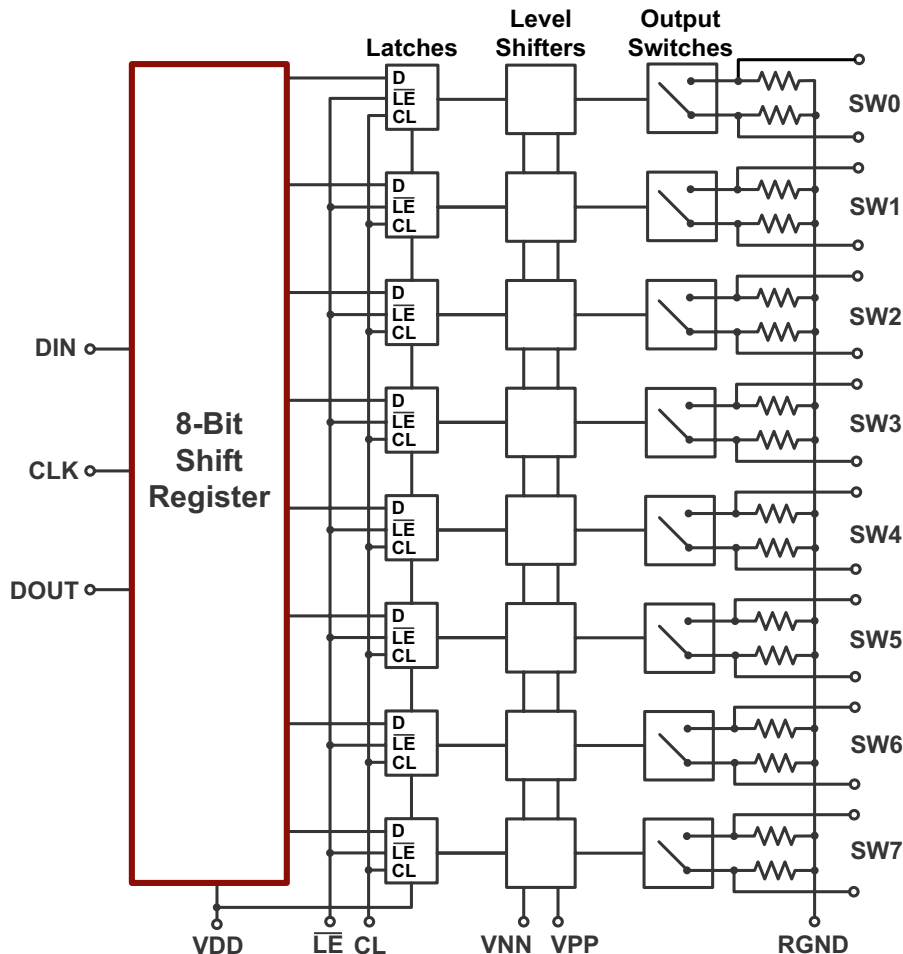
- ▶ Medical ultrasound imaging
- ▶ Piezoelectric transducer drivers

General Description

The Supertex HV230 is a low charge injection 8-channel, high-voltage, analog switch integrated circuit (IC) with bleed resistors. This device can be used in applications requiring high voltage switching controlled by low voltage control signals, such as ultrasound imaging and printers. The bleed resistors eliminate voltage built up on capacitive loads such as piezoelectric transducers. Input data is shifted into an 8-bit shift register which can then be retained in an 8-bit latch. To reduce any possible clock feed-through noise, Latch Enable (\overline{LE}) should be left high until all bits are clocked in. Using HVCMOS® technology, this switch combines high voltage bilateral DMOS switches and low power CMOS logic to provide efficient control of high voltage analog signals.

This IC is suitable for various combinations of high voltage supplies, e.g., V_{PP}/V_{NN} : +50V/-150V, or +100V/-100V.

Block Diagram

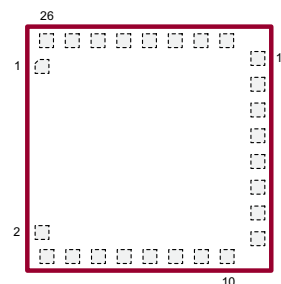


Ordering Information

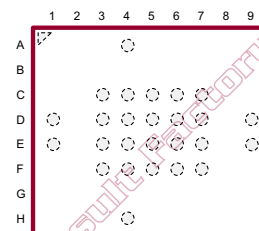
Part Number	Package Option	Packing
HV230G1-G	26-Lead LLGA	400/Tray
HV230GA-G	26-Ball fpBGA	Consult factory

-G denotes a lead (Pb)-free / RoHS compliant package

Pin Configuration



26-Lead LLGA
(top view)



26-Ball fpBGA
(top view)

Absolute Maximum Ratings

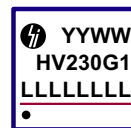
Parameter	Value
V_{DD} logic power supply voltage	-0.5V to +15V
$V_{PP} - V_{NN}$ supply voltage	220V
V_{PP} positive high voltage supply	-0.5V to $V_{NN} + 200V$
V_{NN} negative high voltage supply	+0.5V to -200V
Logic input voltages	-0.5V to $V_{DD} + 0.3V$
Analog signal range	V_{NN} to V_{PP}
Peak analog signal current/channel	3.0A
Storage temperature	-65°C to +150°C
Power dissipation:	
26-Lead LLGA	1.0W
26-Ball fpBGA	1.0W

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Typical Thermal Resistance

Package	θ_{ja}
26-Lead LLGA	41°C/W
26-Ball fpBGA	-

Product Marking



YY = Year Sealed
WW = Week Sealed
L = Lot Number
_____ = "Green" Packaging

Package may or may not include the following marks: Si or

26-Lead LLGA



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Package may or may not include the following marks: Si or

26-Ball fpBGA

Operating Conditions

Sym	Parameter	Value
V_{DD}	Logic power supply voltage ^{1,3}	4.5V to 13.2V
V_{PP}	Positive high voltage supply ^{1,3}	40V to $V_{NN} + 200V$
V_{NN}	Negative high voltage supply ^{1,3}	-40V to -160V
V_{IH}	High level input voltage	$V_{DD} - 1.5V$ to V_{DD}
V_{IL}	Low-level input voltage	0V to 1.5V
V_{SIG}	Analog signal voltage peak-to-peak ²	$V_{NN} + 10V$ to $V_{PP} - 10V$
T_A	Operating free air temperature	0°C to 70°C

Notes:

- Power up/down sequence is arbitrary except GND must be powered-up first and powered-down last.
- V_{SIG} must be $V_{NN} \leq V_{SIG} \leq V_{PP}$ or floating during power up/down transition.
- Rise and fall times of power supplies V_{DD} , V_{PP} and V_{NN} should not be less than 1.0msec.

DC Electrical Characteristics (Over operating conditions unless otherwise specified)

Sym	Parameter	0°C		+25°C			+70°C		Unit	Conditions	
		Min	Max	Min	Typ	Max	Min	Max			
R_{ONS}	Small signal switch ON-resistance	-	30	-	-	38	-	48	Ω	$I_{SIG} = 5.0mA$	$V_{PP} = +40V$ $V_{NN} = -160V$
		-	25	-	-	27	-	32		$I_{SIG} = 200mA$	$V_{PP} = +100V$ $V_{NN} = -100V$
		-	25	-	-	27	-	30		$I_{SIG} = 5.0mA$	$V_{PP} = +160V$ $V_{NN} = -40V$
		-	18	-	-	24	-	27		$I_{SIG} = 200mA$	
		-	23	-	-	25	-	30			
		-	22	-	-	25	-	27			
ΔR_{ONS}	Small signal switch ON-resistance matching	-	20	-	-	20	-	20	%	$I_{SIG} = 5.0mA, V_{PP} = +100V,$ $V_{NN} = -100V$	
R_{ONL}	Large signal switch ON-resistance	-	-	-	15	-	-	-	Ω	$V_{SIG} = V_{PP} - 10V, I_{SIG} = 1.0A$	
R_{INT}	Output switch shunt resistance	-	-	20	-	50	-	-	$K\Omega$	Output switch to R_{GND} $I_{RINT} = 0.5mA$	
I_{SOL}	Switch OFF leakage per switch	-	5.0	-	-	10	-	15	μA	$V_{SIG} = V_{PP} - 10V$	
V_{OS}	DC offset switch OFF	-	300	-	-	300	-	300	mV	No load	
	DC offset switch ON	-	500	-	-	500	-	500	mV	No load	
I_{PPQ}	Quiescent V_{PP} supply current	-	-	-	-	50	-	-	μA	All switches OFF	
I_{NNQ}	Quiescent V_{NN} supply current	-	-	-	-	-50	-	-	μA	All switches OFF	
I_{PPQ}	Quiescent V_{PP} supply current	-	-	-	-	50	-	-	μA	All switches ON, $I_{SW} = 5.0mA$	
I_{NNQ}	Quiescent V_{NN} supply current	-	-	-	-	-50	-	-	μA	All switches ON, $I_{SW} = 5.0mA$	
I_{SW}	Switch output peak current	-	3.0	-	-	2.0	-	2.0	A	V_{SIG} duty cycle -0.1%	
f_{SW}	Output switching frequency	-	-	-	-	50	-	-	kHz	Duty cycle = 50%	
I_{PP}	Supply current	-	6.5	-	-	7.0	-	8.0	mA	$V_{PP} = +40V$ $V_{NN} = -160V$	All output switches are turning On and Off at 50kHz with no load
		-	4.0	-	-	5.0	-	5.5		$V_{PP} = +100V$ $V_{NN} = -100V$	
		-	4.0	-	-	5.0	-	5.5		$V_{PP} = +160V$ $V_{NN} = -40V$	
I_{NN}	Supply current	-	6.5	-	-	7.0	-	8.0	mA	$V_{PP} = +40V$ $V_{NN} = -160V$	All output switches are turning On and Off at 50kHz with no load
		-	4.0	-	-	5.0	-	5.5		$V_{PP} = +100V$ $V_{NN} = -100V$	
		-	4.0	-	-	5.0	-	5.5		$V_{PP} = +160V$ $V_{NN} = -40V$	
I_{DD}	Logic supply average current	-	4.0	-	-	4.0	-	4.0	mA	$f_{CLK} = 5.0MHz, V_{DD} = 5.0V$	
I_{DDQ}	Logic supply quiescent current	-	10	-	-	10	-	10	μA	---	
I_{SOR}	Data out source current	0.45	-	0.45	-	-	0.40	-	mA	$V_{OUT} = V_{DD} - 0.7V$	
I_{SINK}	Data out sink current	0.45	-	0.45	-	-	0.40	-	mA	$V_{OUT} = 0.7V$	
C_{IN}	Logic input capacitance	-	10	-	-	10	-	10	pF	---	

AC Electrical Characteristics (Over recommended operating conditions, $V_{DD} = 5.0V$, unless otherwise specified)

Sym	Parameter	0°C		+25°C			+70°C		Unit	Conditions
		Min	Max	Min	Typ	Max	Min	Max		
t_{SD}	Set up time before \overline{LE} rises	150	-	150	-	-	150	-	ns	---
t_{WLE}	Time width of \overline{LE}	150	-	150	-	-	150	-	ns	---
t_{DO}	Clock delay time to data out	55	150	60	-	150	70	150	ns	---
t_{WCL}	Time width of CL	150	-	150	-	-	150	-	ns	---
t_{SU}	Set up time data to clock	15	-	15	-	-	20	-	ns	---
t_H	Hold time data from clock	35	-	35	-	-	35	-	ns	---
f_{CLK}	Clock frequency	-	5.0	-	-	5.0	-	5.0	MHz	50% Duty cycle, $f_{DATA} = f_{CLK}/2$
t_R, t_F	Clock rise and fall times	-	1.0	-	-	1.0	-	1.0	μs	---
t_{ON}	Turn ON time	-	5.0	-	-	5.0	-	5.0	μs	$V_{SIG} = V_{PP} - 10V, R_L = 10k\Omega$
t_{OFF}	Turn OFF time	-	5.0	-	-	5.0	-	5.0	μs	$V_{SIG} = V_{PP} - 10V, R_L = 10k\Omega$
dv/dt	Maximum V_{SIG} slew rate	-	20	-	-	20	-	20	V/ns	$V_{PP} = +160V, V_{NN} = -40V$
		-	20	-	-	20	-	20		$V_{PP} = +100V, V_{NN} = -100V$
		-	20	-	-	20	-	20		$V_{PP} = +40V, V_{NN} = -160V$
K_O	OFF isolation	-30	-	-30	-	-	-30	-	dB	$f = 5.0MHz,$ $1.0k\Omega/15pF$ load
		-58	-	-58	-	-	-58	-		$f = 5.0MHz, 50\Omega$ load
K_{CR}	Switch crosstalk	-60	-	-60	-	-	-60	-	dB	$f = 5.0MHz, 50\Omega$ load
I_{ID}	Output switch isolation diode current	-	300	-	-	300	-	300	mA	300ns pulse width, 2.0% duty cycle
$C_{SG(OFF)}$	OFF capacitance SW to GND	5.0	17	5.0	-	17	5.0	17	pF	0V, $f = 1.0MHz$
$C_{SG(ON)}$	ON capacitance SW to GND	25	50	25	-	50	25	50	pF	0V, $f = 1.0MHz$
$+V_{SPK}$	Output voltage spike	-	-	-	-	150	-	-	mV	$V_{PP} = +40V, V_{NN} = -160V,$ $R_L = 50\Omega$
$-V_{SPK}$		-	-	-	-	150	-	-		
$+V_{SPK}$		-	-	-	-	150	-	-		$V_{PP} = +100V, V_{NN} = -100V,$ $R_L = 50\Omega$
$-V_{SPK}$		-	-	-	-	150	-	-		
$+V_{SPK}$		-	-	-	-	150	-	-		$V_{PP} = +160V, V_{NN} = -40V,$ $R_L = 50\Omega$
$-V_{SPK}$		-	-	-	-	150	-	-		

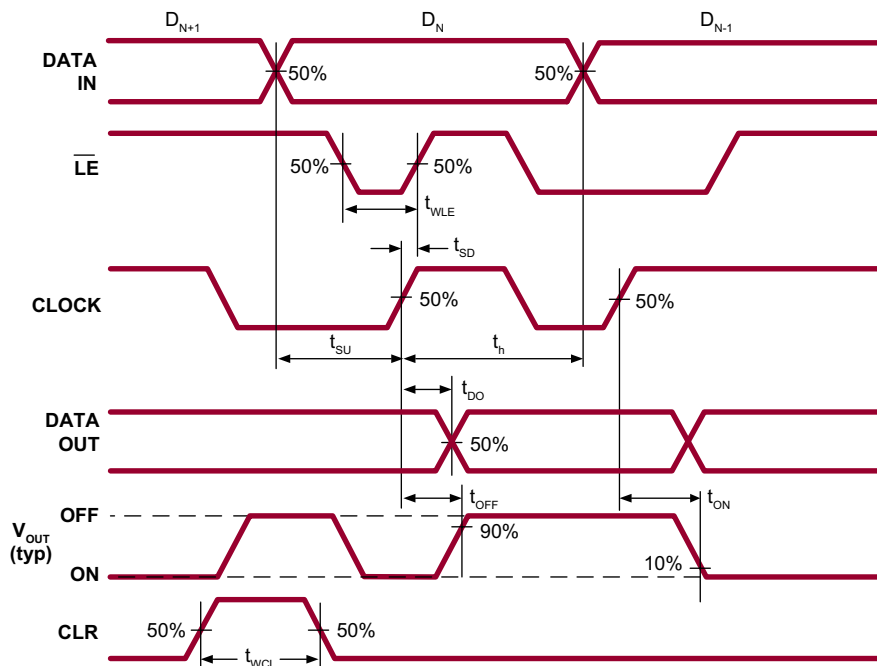
Truth Table

D0	D1	D2	D3	D4	D5	D6	D7	\overline{LE}	CLK	SW0	SW1	SW2	SW3	SW4	SW5	SW6	SW7
L								L	L	OFF							
H								L	L	ON							
	L							L	L		OFF						
	H							L	L		ON						
		L						L	L			OFF					
		H						L	L			ON					
			L					L	L				OFF				
			H					L	L				ON				
				L				L	L					OFF			
				H				L	L					ON			
					L			L	L						OFF		
					H			L	L						ON		
						L		L	L							OFF	
						H		L	L							ON	
							L	L	L								OFF
							H	L	L								ON
X	X	X	X	X	X	X	X	H	L	Hold Previous State							
X	X	X	X	X	X	X	X	X	H	All Switches OFF							

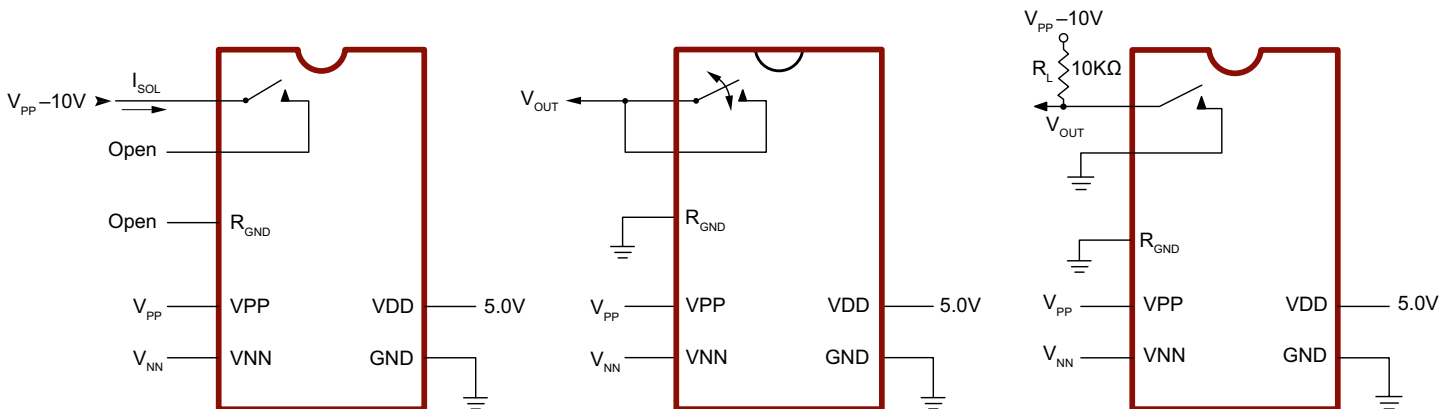
Notes:

1. The eight switches operate independently.
2. Serial data is clocked in on the L to H transition of the CLK.
3. The switches go to a state retaining their present condition at the rising edge of \overline{LE} . When \overline{LE} is low the shift register data flow through the latch.
4. D_{OUT} is high when data in the shift register 7 is high.
5. Shift register clocking has no effect on the switch states if \overline{LE} is high.
6. The CLR clear input overrides all other inputs.

Logic Timing Waveforms



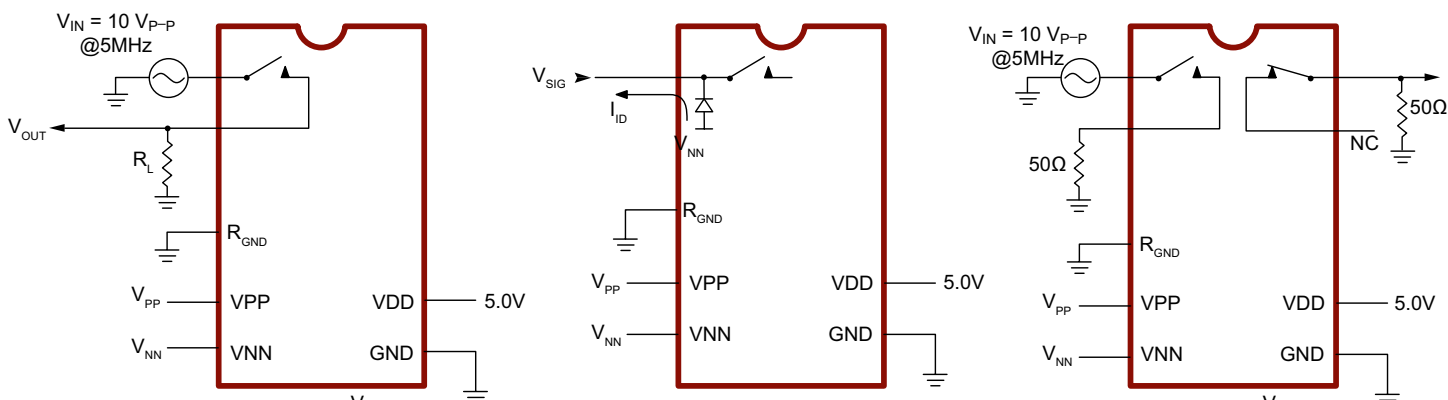
Test Circuits



Switch OFF Leakage

DC Offset ON/OFF

Ton/Toff Test Circuit



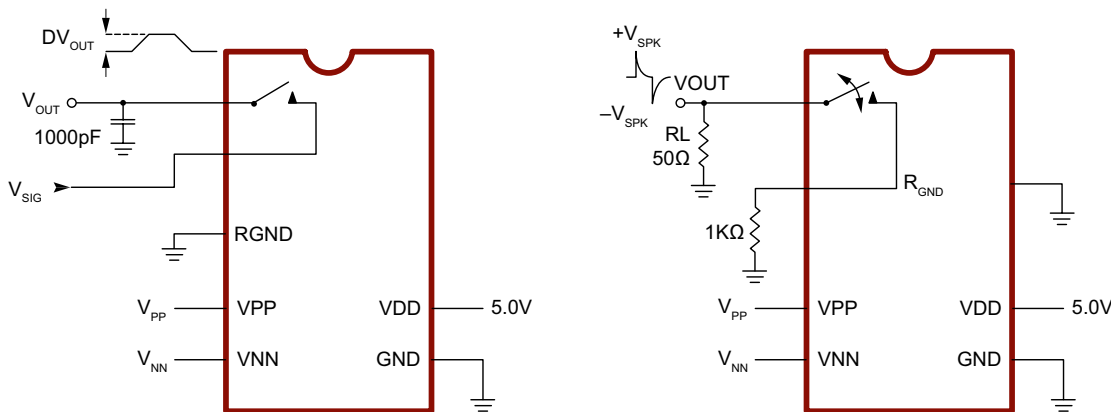
$K_O = 20 \text{Log} \frac{V_{OUT}}{V_{IN}}$

OFF Isolation

Isolation Diode Current

$K_{CR} = 20 \text{Log} \frac{V_{OUT}}{V_{IN}}$

Crosstalk



$Q = 1000pF \times DV_{OUT}$

Charge Injection

Output Voltage Spike

Pin Description (26-Lead LLGA)

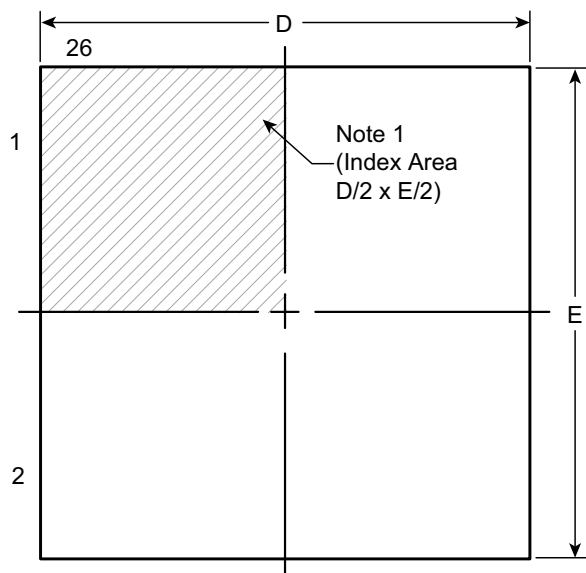
Pin	Function	Pin	Function
1	SW4	14	VDD
2	SW3	15	DIN
3	SW3	16	CLK
4	SW2	17	\overline{LE}
5	SW2	18	CL
6	SW1	19	DOUT
7	SW1	20	SW7
8	SW0	21	SW7
9	SW0	22	SW6
10	VPP	23	SW6
11	VNN	24	SW5
12	RGND	25	SW5
13	GND	26	SW4

Pin Description (26-Ball fpBGA)

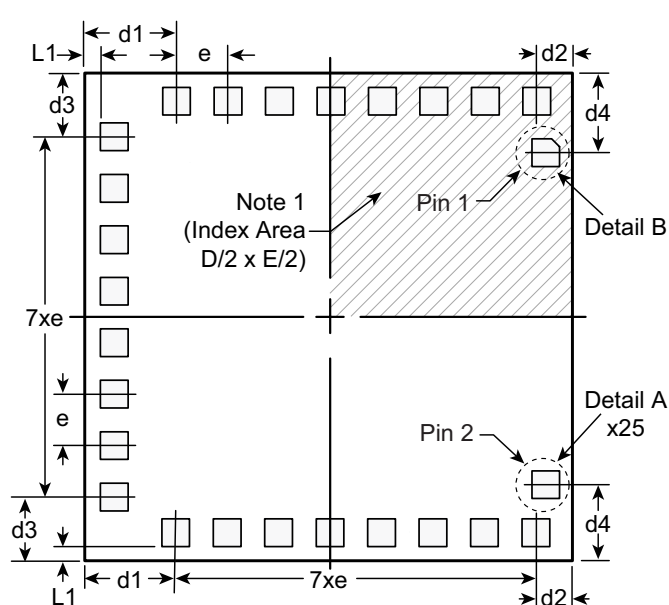
Ball Location	Function	Ball Location	Function
A4	SW1	E1	SW4
C3	SW2	E3	SW4
C4	SW1	E4	SW5
C5	SW0	E5	SW7
C6	VPP	E6	\overline{LE}
C7	VNN	E7	CLK
D1	SW3	E9	DIN
D3	SW3	F3	SW5
D4	SW2	F4	SW6
D5	SW0	F5	SW7
D6	RGND	F6	DOUT
D7	GND	F7	CLR
D9	VDD	H4	SW6

26-Lead LLGA Package Outline (G1)

6.00x6.00mm body, 0.60mm height (max), 0.65mm pitch



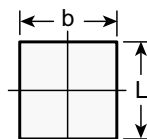
Top View



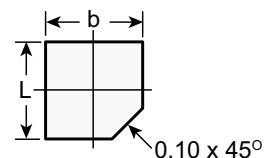
Bottom View



Side View



Detail A



Detail B

Note:
 1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 Identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

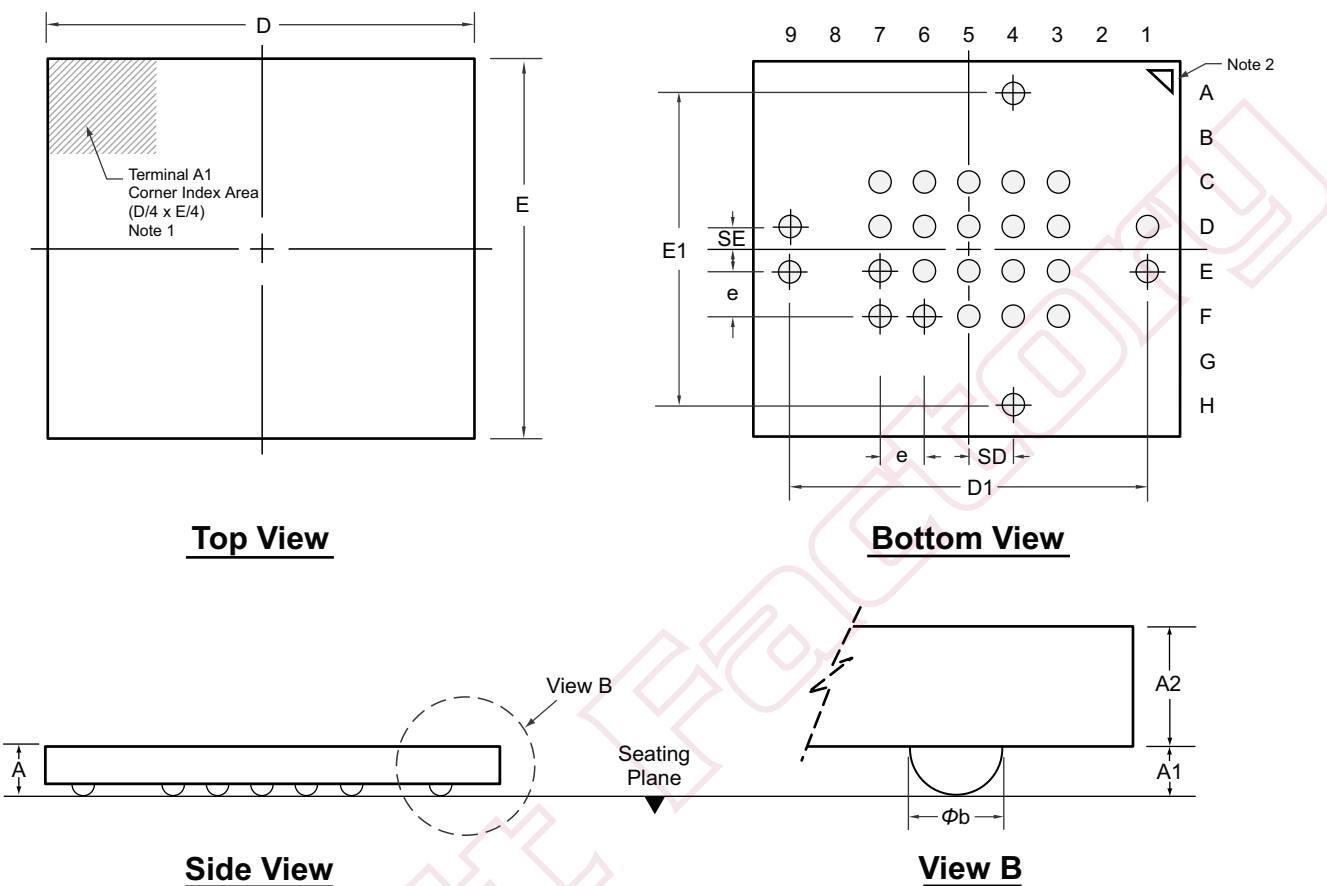
Symbol	A	A1	b	D	d1	d2	d3	d4	E	e	L	L1	
Dimension (mm)	MIN	0.50	0.00	0.25	5.90	1.050 REF	0.400 REF	0.725 REF	0.925 REF	5.90	0.65 BSC	0.25	0.10 REF
	NOM	0.55	-	0.35	6.00					6.00		0.35	
	MAX	0.60	0.05	0.45	6.10					6.10		0.45	

Drawings not to scale.

Supertex Doc. #: DSPD-26LLGAG1, Version A090808.

26-Ball fpBGA Package Outline (GA)

6.00x5.35mm body, 1.20mm height (max), 0.65mm pitch



Notes:

1. A Ball A1 identifier must be located in the index area indicated. The Ball A1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
2. Corner A1 identifier (actual shape may vary).

Symbol		A	A1	A2	ϕ_b	D	D1	E	E1	e	SD	SE
Dimension (mm)	MIN	0.844	0.18	0.664	0.25	5.90	5.20 BSC	5.25	4.55 BSC	0.65 BSC	0.65 BSC	0.325 BSC
	NOM	0.994	0.23	0.764	0.30	6.00		5.35				
	MAX	1.200	0.28	0.864	0.35	6.10		5.45				

Drawings not to scale.
Supertex Doc. #: DSPD-26fpBGAGA, Version A092208.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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